Measurements of loss tangent and relative permittivity of LTCC ceramics at varying temperatures and frequencies

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ABSTRACT

Precise knowledge of microwave properties of LTCC materials is crucial for efficient design of microwave systems, especially for design of communication filters. In this paper relative permittivity ε_r and loss tangent tan δ of a variety of LTCC ceramics manufactured by Heraeus Circuit Materials Division are presented for frequencies of 3.3 GHz and 5.5 GHz at room temperature and also for temperatures varying from -30° C to 25° C at a frequency of 3.3 GHz. The measurement system for microwave characterisation of LTCC materials was based on the split post dielectric resonator and the Transmission Mode Q-factor techniques with random uncertainty in ε_r and in tan δ better than 0.5% and 2.6% respectively.

Keywords: Dielectric Properties; LTCC; Substrates

1. Introduction

The integration and miniaturization of passive circuits have lagged significantly developments in electronic circuits containing active elements for several years. Low Temperature Co-Fired Ceramics (LTCC), allow 3-dimensional circuits to be constructed within a ceramic block that enables 'burying' of passive elements: resistors; inductors and capacitors. The three dimensional circuit format provides a much needed advance in the miniaturisation of devices, however the materials used sometimes required firing temperatures that were too high to allow the use of the highly conductive and low loss materials that are essential for effective performance. In addition, some of the methods required circuit construction in a serial process, resulting in longer manufacturing times. Hence until recently LTCC materials found limited applications.

In last few years the increase in the level of functions required of wireless communications has necessitated the use of higher frequency ranges. Also demands of consumers for faster, smaller, and cheaper communication devices have put pressure on the wireless communications market to integrate passive elements and resulted in significant advances in manufacturing and properties of 3D LTCC circuits¹⁻⁴. All layers can be now processed in parallel, reducing the production cost and time.

Lower temperature firing of ceramic blocks allows utilization of highly conductive metals such as gold or silver and decrease of line-loss. As a result of this progress a very rapid growth of applications of Low Temperature Co-fired Ceramics in wireless communications has been observed recently. This phenomenon is directly related to ability of the LTCC technology for parallel processing, precisely defined parameters and stable performance over the lifetime, high performance conductors, three dimensional microwave structures and very high density of interconnects.

Currently LTCC materials are manufactured by several companies and exhibit ε_r from 3.9 to 10 or more and loss tangent of below 0.005 at frequency of 5 GHz. As frequencies of wireless MMIC systems increase toward 40 GHz and above for many applications, device performance and circuit technology become increasingly critical. Hence decrease of losses of LTCC materials is particularly important for future progress in LTCC wireless applications. Accurate measurements of loss tangent and the real relative permittivity at microwave frequencies still represent a complex problem. In this paper we present precise measurements of LTCC materials from four differing manufacturing technologies using the split-post dielectric resonator technique and data processing by the Transmission Mode Q-Factor technique.

2. Low Temperature Co-fired Ceramics tested

Four different LTCC materials were tested, three manufactured by Heraeus CMD^{3,4} and one other material (CTX). The Heraeus materials were:-

CT700, a long established general purpose, lead free LTCC material,

CT800, a modified version of CT700,

CT2000, a material developed for microwave use with a low loss and low temperature coefficient of frequency - T_{f} .

3. Split Post Dielectric Resonator, Measurement System and Computations Procedures for Characterisation of LTCC Materials

Split post dielectric resonators (SPDR) have been used for measurements of microwave properties of substrate materials for MMIC since 198^{5-12} . In this technique a tested substrate is placed between two low loss dielectric rods situated in a metallic enclosure, as shown in Fig. 1. Typically TE₀₁₈ mode is used for microwave characterization of dielectric substrates since this mode is insensitive to the presence of air gaps perpendicular to z-axis of the resonator.



Fig. 1 Split-post resonator

The real part of the sample'complex permittivity is computed from measured resonant frequencies of the resonator using the following equation¹²:

$$\varepsilon'_{r} = 1 + \frac{f_0 - f_s}{h f_0 K_{\varepsilon}(\varepsilon'_r, h)} \tag{1}$$

where: h is thickness of the sample under test, f_o is the resonant frequency of the empty SPDR, f_s is the resonant frequency of the resonator with the dielectric sample. K_ϵ is a function of ϵ_r' and h, and has been evaluated for a number of of ϵ_r' and h using Rayleigh-Ritz technique. Iterative procedure is then used to evaluate subsequent values of K_ϵ and

 ε_r ' from equation (1).

The loss tangent of the tested substrate is calculated from the measured unloaded Q_0 -factors of the SPDR with and without the sample based on equation (2)

$$\tan \delta = (Q_0^{-1} - Q_{DR}^{-1} - Q_c^{-1}) / \rho_{es}$$
⁽²⁾

where p_{es} electric energy filling factor of the sample, Q_{DR}^{-1} and Q_c^{-1} denote losses of the metallic and dielectric parts of the resonator respectively.

The numerical procedure of permittivity and loss tangent computations has been based on the rigorous electromagnetic modeling of the split post resonant structure using the Rayleigh-Ritz technique. The procedure has been described in detail in¹² and it has been implemented as a user-friendly computer program for each of our split post resonators^{13,14}.

For our measurements of Low Temperature Cofired Ceramic substrates we used two split post dielectric resonators. At room temperature, one resonator had resonant frequency f_0 of 3.3GHz and the unloaded Q-factor of 23250, while the other structure has f_0 of 5.5 GHz and Q_0 of 12250.

The measurement system used for the microwave characterisation of the LTCC materials sample is shown in Fig. 2. The system consisted of Network Analyser (HP 8722C), closed cycle refrigerator (APD DE-204), temperature controller (LTC-10), vacuum Dewar, a PC and the Split-Post dielectric resonator in transmission mode (as discussed above).



Fig. 2. Experimental set-up to measure the Q-factor and f_o of LTCC SPDR

To measure Q_o -factor of the SPDR we used very low coupling of the resonator to the external circuitry and applied the approximation

$$Q_0 \approx Q_{L}$$
. (3)

To obtain precise values of the Q_L-factor of the split-post resonator and hence accurate values of tand of LTCC substrates we have measured 1601 values of S₂₁ parameter around the resonance and processed measured data sets using recently developed the Transmission Mode O-Factor Technique^{15, 16}. The TMQF technique involves fitting of an ideal Q-circle to the measured data and a phase correction that removes effects of noise, non-calibrated measurement cables, connectors, coupling structures, cross-talk between the coupling loops, and impedance mismatch from the measured data. The TMQF is especially useful in cryogenic measurements since these measurements are typically done in the transmission mode and measurements systems contain cables and connectors that are difficult to calibrate. As our tests were performed with very low coupling coefficients β_1 and β_2 , a modified version of the fundamental relationship of the TMQF technique¹⁴ was used for the Q-circle fitting of measured S_{21} data sets in the TMQF software, namely as:

$$S_{21} = \frac{2R_c Y_{ex1} Y_{ex2}}{G_o \left(1 + \beta_1 + \beta_2\right) \left(1 + j2Q_L \frac{\omega - \omega_L}{\omega_L}\right)}$$

$$\approx \frac{2R_c Y_{ex1} Y_{ex2}}{G_o \left(1 + j2Q_L \frac{\omega - \omega_o}{\omega_o}\right)}$$
(4)

where G_o is the conductance of an ideal resonator, R_c is the characteristic impedance of measurement system, Y_{ex1} and Y_{ex2} are the external admittances including the coupling losses and reactance, ω_o and ω_L are unloaded and loaded resonant frequencies respectively.

The accuracy of the TQMF is better than 1% for practical measurement ranges and is applicable to a relatively wide range of couplings. The range of Q-factors measurable is from 10^3 to $(10^7)^{15,16}$.

Measurements of Low Temperature Co-Fired Ceramics from four differing processes as described earlier in Section 2 were conducted at room temperature at frequencies of 5.5 GHz and 3.3 GHz using two split post resonators. Temperature dependences of the real relative permittivity ε_r and loss tangent were measured using the 3.3 GHz SPDR in the temperature range from -30° C to 27° C.

For variable temperature measurements S_{21} data sets were measured first for the empty resonator and then for the resonator with a given LTCC sample. The TMQF technique was then used to obtain f_o and Q_o values of the empty split post resonator and of the resonator with the LTCC sample, at exactly the same temperatures. The microwave parameters ϵ_r and tan δ were computed using the software^{13, 14} from the resonant frequencies and unloaded Q_o factors.

To access accuracy of our measurements we performed uncertainty analysis of measured ε_r and $tan\delta$. The random relative uncertainty in real part of relative permittivity, $\Delta_r \varepsilon_r$, was calculated using^{13, 14} software assuming uncertainty in the LTCCC samples' thickness of 3µm and found to be below 0.5% for both split post dielectric resonators. The random relative uncertainty in loss tangent, $\Delta_r \tan \delta$, was calculated to be at most 2.5% using the same software and assuming 1% uncertainty in the Qo-factor values. The absolute uncertainty in tand has been assessed to be maximum 8.8% assuming 4% uncertainty in the Q₀factor values.



4. Microwave Properties of LTCC Materials at frequency of 3.3GHz and 5.5GHz

Fig. 3 Real relative permittivity and loss tangent of LTCC samples (CT2000) at 3.3 GHz



Fig. 4 Real relative permittivity and loss tangent of LTCC samples (CTX) at 3.3 GHz.

Measured values of loss tangent and real relative permittivity of the Low Temperature Co-fired Ceramics (52x52mm) at room temperature at two frequencies as well as for temperatures varying from 240K to 295K at 3.3 GHz are presented in Table 1.



Fig. 5 Real relative permittivity and loss tangent of LTCC samples (CT700) at 3.3 GHz



Fig. 6 Real relative permittivity and loss tangent of LTCC samples (CT800) at 3.3 GHz

5. Conclusions

We have shown precise measurements of real part of relative permittivity and loss tangent of four types of Low Temperature Co-Fired Ceramics. The measurements were performed using two split post dielectric resonators for temperatures varying from 240K to 295K. The tested LTCC samples exhibited values ε_r of 9.2, 7.65, 7.5 and 6.9 independent on temperature at 3.3 GHz. Measurements at 5.5 GHz showed slightly smaller values of ε_r .

The loss tangent of LTCC samples was 0.0018, 0.00249, 0.00212 and 0.00197 at 3.3. GHz and increased to 0.00214, 0.00257, 0.00227 and 0.00206 respectively at 5.5 GHz. The CT2000 samples exhibited the smallest loss tangent of four types of LTCC materials tested. The dependence of tan δ showed either a very slight decrease (CT2000 and CTX), no change (CT800) or very slight increase (CT700) with temperature from 240K to 295K.

Acknowledgements

This work was done under the financial support of ARC Large grant A00105170 and Heraeus Circuit Materials Division. The second author acknowledges the James Cook University Post Doctoral Fellowship.

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Table 1 The measured dielectric properties of LTCC samples measured at frequencies 3.3 GHz and 5.5 GHz and at room temperature.

Sample	Thickness	Freq.	ε _r	tanδ	random	random	absolute
	(mm)	(GHz)			$\Delta_{\rm r} \varepsilon_{\rm r}$ in %	$\Delta_{\rm r}$ tan δ in %	Δ _r tanδ in %
					(∆h = 3µm)	$(\delta Q_0 = 1\%)$	$(\delta Q_0 = 4\%)$
CT2000	0.700	3.3	9.234	0.00181	0.37	2.0	7.9
CT2000	0.700	5.5	9.19	0.00214	0.37	1.9	7.6
CT700	0.720	3.3	6.924	0.00212	0.35	2.1	8.3
CT700	0.720	5.5	6.890	0.00227	0.35	2.2	8.5
CT800	0.750	3.3	7.542	0.00197	0.34	2.0	8.0
CT800	0.750	5.5	7.515	0.00206	0.34	2.2	8.4
CTX	0.556	3.3	7.705	0.00249	0.46	2.1	8.3
CTX	0.556	5.5	7.573	0.00257	0.46	2.3	8.8